

Altera Device Package Information

04R-00446-3.0

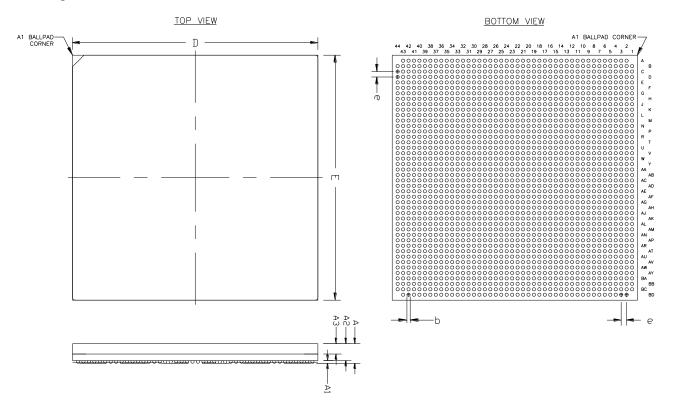
1932-Pin FineLine Ball-Grid Array (FBGA) - Flip Chip - Flat Top Single-Piece Lid - A:3.90

- All dimensions and tolerances conform to ASME Y14.5M 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information		
Description	Specification	
Ordering Code Reference	F	
Package Acronym	FBGA	
Substrate Material	ВТ	
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)	
JEDEC Outline Reference	MS-034 Variation: AAW-1	
Lead Coplanarity	0.010 inch (0.25 mm)	
Weight	35.5 g (Typ.)	
Moisture Sensitivity Level	Printed on moisture barrier bag	

Package Outline Dimension Table				
Symbol	Millimeters			
	Min.	Nom.	Max.	
Α	3.50	3.70	3.90	
A1	0.40	0.50	0.60	
A2	2.90	3.20	3.50	
А3	1.85	1.90	1.95	
D	45.00 BSC			
E	45.00 BSC			
b	0.50	0.60	0.70	
е	1.00 BSC			

Package Outline



Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
May 2012	1.0	Initial release
July 2012	2.0	Heading has been change from Top Flat Single-Piece Lid to Flat Top Single-Piece Lid
May 2013	3.0	Include dimension "b" in the Package Outline drawing at Page 2.



101 Innovation Drive San Jose, CA 95134 www.altera.com © 2013 Altera Corporation. All rights reserved. ALTERA, ARRIA, CYCLONE, HARDCOPY, MAX, MEGACORE, NIOS, QUARTUS and STRATIX are Reg. U.S. Pat. & Tm. Off. and/or trademarks of Altera Corporation in the U.S. and other countries. All other trademarks and service marks are the property of their respective holders as described at www.altera.com/common/legal.html. Altera warrants performance of its semiconductor products to current specifications in accordance with Altera's standard warranty, but reserves the right to make changes to any products and services at any time without notice. Altera assumes no responsibility or liability arising out of the application or use of any information, product, or service described herein except as expressly agreed to in writing by Altera. Altera customers are advised to obtain the latest version of device specifications before relying on any published information and before placing orders for products or services.